



**THE DATASHEET OF
1ED3122MU12HXUMA1**



EiceDRIVER™ 1ED31xxMU12H Compact

Datasheet

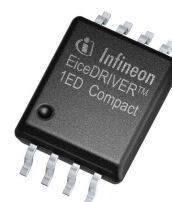
Single-channel 5.7 kV (rms) isolated gate driver IC with active Miller clamp or separate output

Feature list

- Single channel isolated gate driver
- For use with 600 V/650 V/1200 V/1700 V/2300 V IGBTs, Si and SiC MOSFETs
- Up to 14.0 A typical peak output current
- 40 V absolute maximum output supply voltage
- High common-mode transient immunity CMTI > 200 kV/μs
- Separate source and sink outputs or active Miller clamp with active shutdown and short circuit clamping
- Galvanically isolated coreless transformer gate driver
- 3.3 V and 5 V input supply voltage
- Suitable for operation at high ambient temperature and in fast switching applications
- UL 1577 certification $V_{ISO} = 5.7$ kV (rms) for 1 min (File E311313)

Potential applications

- AC and brushless DC motor drives
- High voltage DC-DC converter and DC-AC inverter
- Induction heating resonant application
- UPS-systems
- Commercial air-conditioning (CAC)
- Server and telecom switched mode power supplies (SMPS)
- Solar inverters, e.g. for 1500 V (DC) systems



PG-DSO-8

Product validation

Qualified for industrial applications according to the relevant tests of JEDEC47/20/22.

Device information

| Product type | Typical output current and configuration | UVLO ($V_{UVLOL2,min}$) | Certification (File E311313) | Package |
|------------------------------|---|---------------------------|------------------------------|----------|
| 1ED3120MU12H | 5.5 A separate source and sink | 8.0 V | UL | PG-DSO-8 |
| 1ED3121MU12H | 5.5 A separate source and sink | 10.5 V | UL | PG-DSO-8 |
| 1ED3122MU12H | 10.0 A and 3.0 A clamp | 8.0 V | UL | PG-DSO-8 |
| 1ED3123MU12H | 14.0 A separate source and sink | 8.0 V | UL | PG-DSO-8 |
| 1ED3124MU12H | 14.0 A separate source and sink | 10.5 V | UL | PG-DSO-8 |
| 1ED3131MU12H | 5.5 A separate source and sink, 180 ns minimum input pulse suppression time | 10.5 V | UL | PG-DSO-8 |

Description

Description

The 1ED31xxMU12H (1ED-X3 Compact) gate driver ICs are galvanically isolated single channel gate driver ICs for IGBT, MOSFET and SiC MOSFET in PG-DSO-8 package. They provide a typical output current of up to 14.0 A on separate source and sink pins or a typical output current of 10.0 A with an additional 3.0 A active Miller clamp.

The input logic pins operate on a wide input voltage range from 3 V to 15 V using CMOS threshold levels to support 3.3 V microcontrollers.

Data transfer across the isolation barrier is realized by the coreless transformer technology.

All variants have logic input and driver output undervoltage lockout (UVLO), and active shutdown.

The gate drivers are certified according to UL 1577

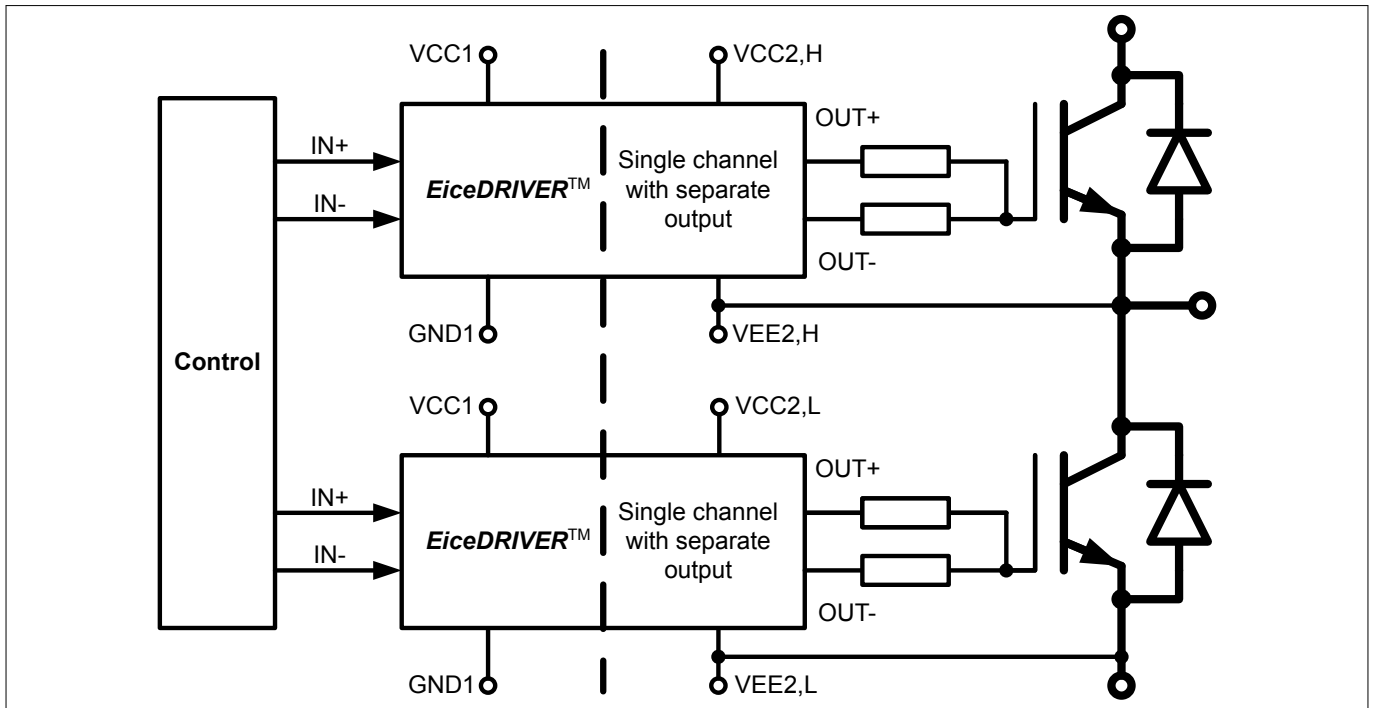


Figure 1 Typical application using separate output variant

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1 Block diagram reference

1 Block diagram reference

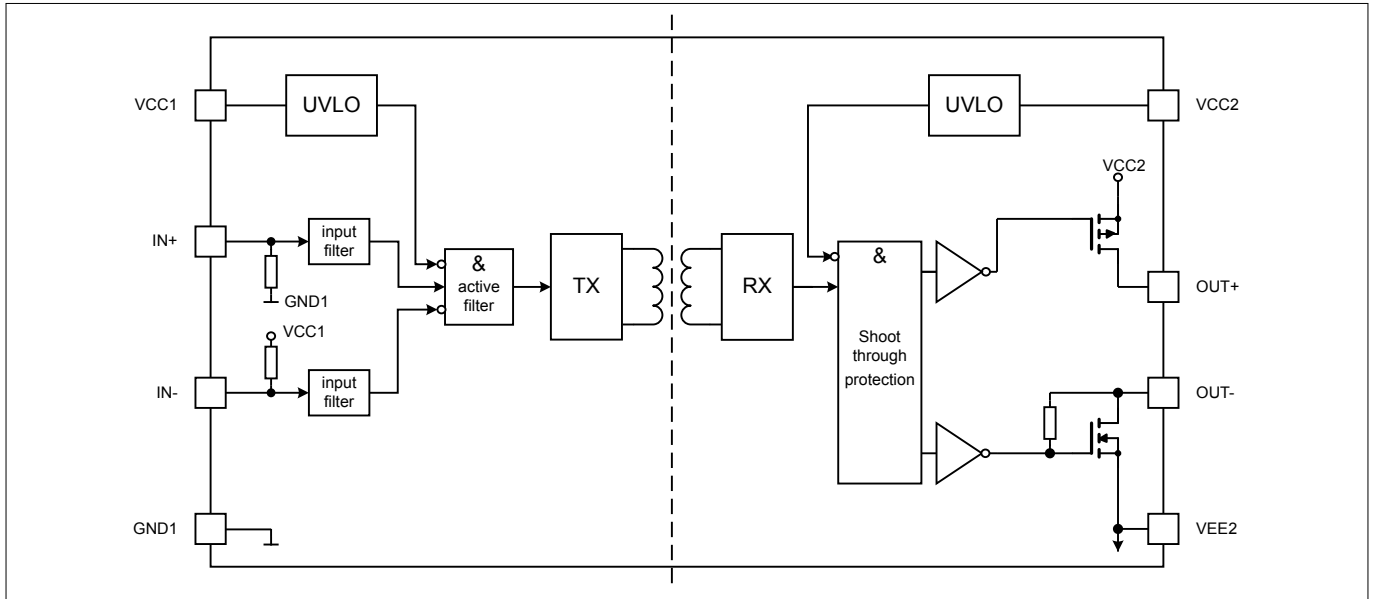


Figure 2 Block diagram separate source and sink output variants

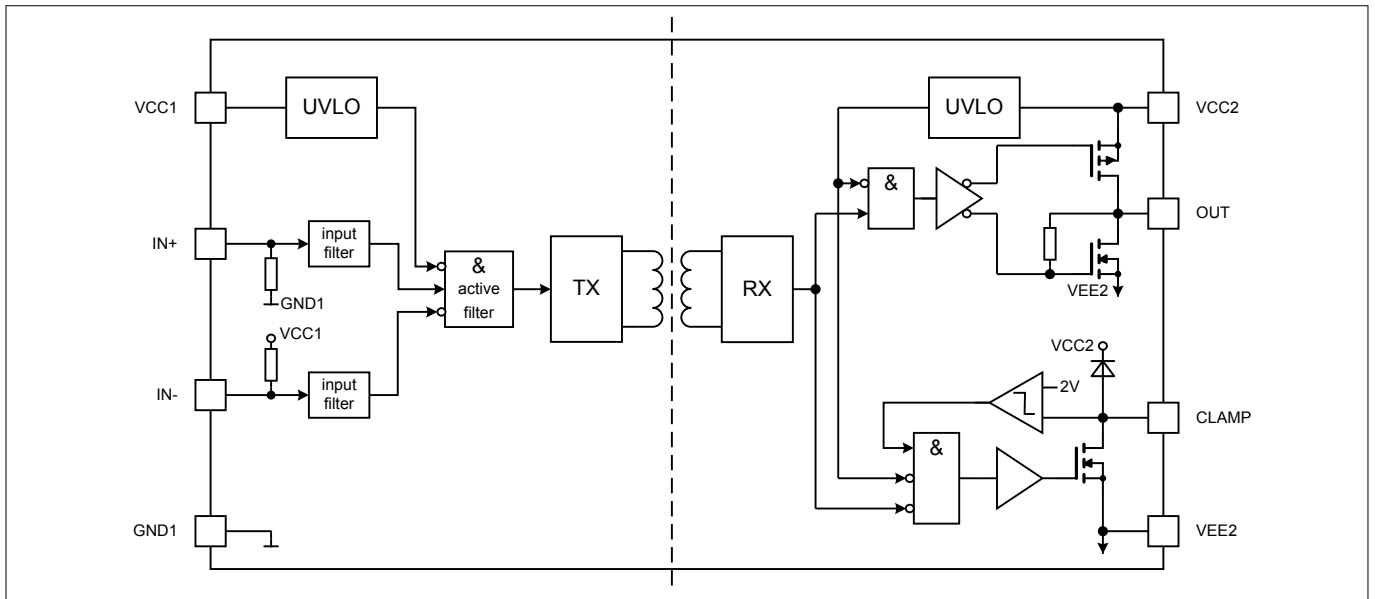


Figure 3 Block diagram output with CLAMP variants

2 Related products

2 Related products

Note: Please consider the gate driver IC power dissipation and insulation requirements for the selected power switch and operating condition.

| Product group | Product name | Description |
|------------------------------|-----------------------------------|---|
| TRENCHSTOP™ IGBT Discrete | IKQ75N120CS6 | High Speed 1200 V, 75 A IGBT with anti-parallel diode in TO247-3 |
| | IKW15N120BH6 | High Speed 1200 V, 15 A IGBT with anti-parallel diode in TO247 |
| | IHW40N120R5 | Reverse conducting 1200 V, 40 A IH IGBT with integrated diode in TO247 |
| CoolSiC™ SiC MOSFET Discrete | IMBF170R650M1 | 1700 V, 650 mΩ SiC MOSFET in TO263-7 package |
| | IMBG120R045M1H | 1200 V, 45 mΩ SiC MOSFET in TO263-7 package |
| | IMZ120R350M1H | 1200 V, 350 mΩ SiC MOSFET in TO247-4 package |
| | IMZA65R027M1H | 650 V, 27 mΩ SiC MOSFET in TO247-4 package |
| | IMW65R107M1H | 650 V, 107 mΩ SiC MOSFET in TO247-3 package |
| CoolSiC™ SiC MOSFET Module | FS45MR12W1M1_B11 | EasyPACK™ 1B 1200 V / 45 mΩ sixpack module |
| | FF6MR12W2M1_B11 | EasyDUAL™ 2B 1200 V, 6 mΩ half-bridge module |
| | F3L11MR12W2M1_B74 | EasyPACK™ 2B 1200 V, 11 mΩ 3-Level module in Advanced NPC (ANPC) topology |
| | F4-23MR12W1M1_B11 | EasyPACK™ 1B 1200 V, 23 mΩ fourpack module |
| TRENCHSTOP™ IGBT Modules | F4-200R17N3E4 | EconoPACK™ 3 1700 V, 200 A fourpack IGBT module |
| | FS150R17N3E4 | EconoPACK™ 3 1700 V, 150 A sixpack IGBT module |
| | FF650R17IE4 | PrimePACK™ 3 1700 V, 650 A half-bridge dual IGBT module |
| | FF1000R17IE4 | PrimePACK™ 3 1700 V, 1000 A half-bridge dual IGBT module |
| | FF1200R17IP5 | PrimePACK™ 3+ 1700 V, 1200 A dual IGBT module |
| | FF1500R17IP5 | PrimePACK™ 3+ 1700 V, 1500 A dual IGBT module |
| | FF1500R17IP5R | PrimePACK™ 3 1700 V, 1500 A dual IGBT module |
| | FF1800R17IP5 | PrimePACK™ 3+ 1700 V, 1800 A dual IGBT module |
| | FP10R12W1T7_B11 | EasyPIM™ 1B 1200 V, 10 A three phase input rectifier PIM IGBT module |
| | FS100R12W2T7_B11 | EasyPACK™ 2B 1200 V, 100 A sixpack IGBT module |
| | FP150R12KT4_B11 | EconoPIM™ 3 1200V three-phase PIM IGBT module |
| | FS200R12KT4R_B11 | EconoPACK™ 3 1200 V, 200 A sixpack IGBT module |

Table 1 Evaluation boards

| Part number | Description |
|-----------------------------------|---|
| EVAL-1ED3121MX12H | Half-bridge evaluation board for 1ED3121MU12H |
| EVAL-1ED3122MX12H | Half-bridge evaluation board for 1ED3122MU12H |
| EVAL-1ED3124MX12H | Half-bridge evaluation board for 1ED3124MU12H |

3 Pin configuration and description

3 Pin configuration and description

Pin configuration PG-DSO-8 of 1ED3121MU12H, 1ED3124MU12H, 1ED3120MU12H, 1ED3123MU12H and 1ED3131MU12H

Table 2 Pin configuration

| Pin No. | Name | Function |
|---------|------|---|
| 1 | VCC1 | Positive logic supply |
| 2 | IN+ | Non-inverted driver input (active high) |
| 3 | IN- | Inverted driver input (active low) |
| 4 | GND1 | Logic ground |
| 5 | VEE2 | Power ground |
| 6 | OUT- | Driver sink output |
| 7 | OUT+ | Driver source output |
| 8 | VCC2 | Positive power supply output side |

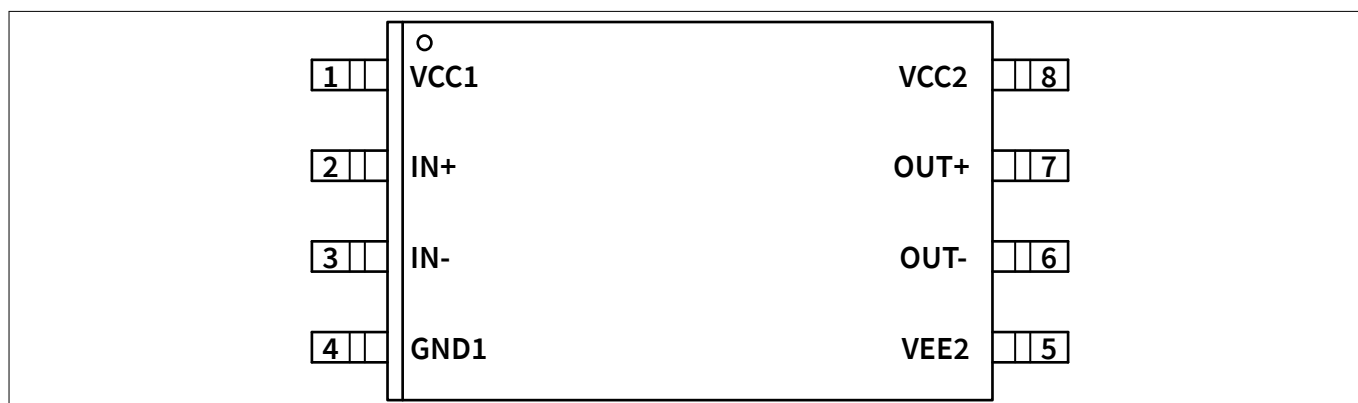


Figure 4 PG-DSO-8 (top view)

Pin configuration PG-DSO-8 of 1ED3122MU12H

Table 3 Pin configuration

| Pin No. | Name | Function |
|---------|-------|---|
| 1 | VCC1 | Positive logic supply |
| 2 | IN+ | Non-inverted driver input (active high) |
| 3 | IN- | Inverted driver input (active low) |
| 4 | GND1 | Logic ground |
| 5 | VEE2 | Power ground |
| 6 | CLAMP | Active Miller clamp output |
| 7 | OUT | Driver source and sink output |
| 8 | VCC2 | Positive power supply output side |

3 Pin configuration and description



Figure 5 PG-DSO-8 (top view)

Pin description

- *VCC1*: Logic input supply voltage of 3.3 V up to 15 V wide operating range
- *GND1*: Ground connection of input circuit.
- *IN+*: Non-inverted control signal for driver output. An internal filter provides robustness against noise at *IN+*. An internal weak pull-down resistor favors off-state.
- *IN-*: Inverted control signal for driver output. An internal filter provides robustness against noise at *IN-*. An internal weak pull-up resistor favors off-state.
- *VCC2*: Positive power supply pin of output driving circuit. A proper blocking capacitor has to be placed close to this supply pin.
- *VEE2*: Reference ground of the output driving circuit. In case of a bipolar supply (positive and negative voltage referred to IGBT emitter) this pin is connected to the negative supply voltage.
- *OUT+*: Driver source output pin to turn on external IGBT. During on-state the driving output is switched to *VCC2*. Switching of this output is controlled by *IN+* and *IN-*. This output will also be turned off at an UVLO event.
- *OUT-*: Driver sink output pin to turn off external IGBT. During off-state the driving output is switched to *VEE2*. Switching of this output is controlled by *IN+* and *IN-*. In case of UVLO an active shut down keeps the output voltage at a low level.
- *OUT*: Combined source and sink output pin to external IGBT. The output voltage will be switched between *VCC2* and *VEE2*. Switching of this output is controlled by *IN+* and *IN-*. In case of an UVLO event this output will be switched off and an active shut down keeps the output voltage at a low level.
- *CLAMP*: The clamp function ties its output to *VEE2* during off-state. It activates as soon as the gate voltage has dropped below 2.0 V referred to *VEE2* after a turn-off command. Connect this pin directly to the IGBT gate to avoid parasitic turn-on of the connected IGBT.

4 Functional description

4 Functional description

The 1ED31xxMU12H (1ED-X3 Compact) are general purpose IGBT gate drivers. Basic control and protection features support fast and easy design of highly reliable systems.

The integrated galvanic isolation between control input logic and driving output stage grants additional safety. Its input voltage supply range supports the direct connection of various signal sources like DSPs and microcontrollers.

4.1 Supply

The driver can operate over a wide supply voltage range, either unipolar or bipolar.

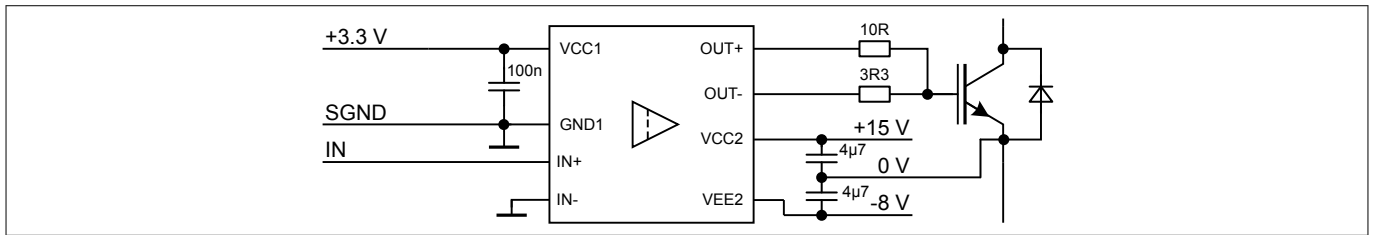


Figure 6 Application example bipolar supply

With bipolar supply the driver is typically operated with a positive voltage of 15 V at VCC2 and a negative voltage of -8 V at VEE2 relative to the emitter of the IGBT. Negative supply can help to prevent a dynamic turn on due to the additional charge which is generated from IGBT's input capacitance.

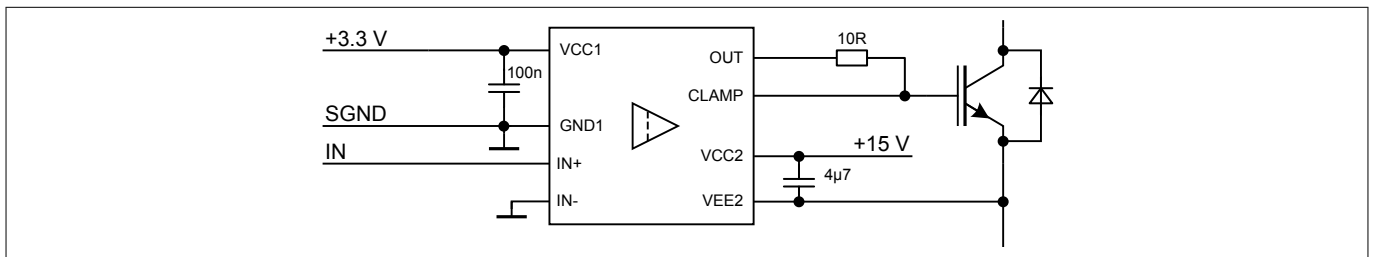


Figure 7 Application example unipolar supply

For unipolar supply configuration the driver is typically supplied with a positive voltage of 15 V at VCC2. In this case, careful evaluation for turn off gate resistor selection is recommended to avoid dynamic turn on. Both supply options are usable with either output configuration separate source and sink as well as output with active Miller clamp.

4 Functional description

4.2 Protection features

4.2.1 Undervoltage lockout (UVLO)

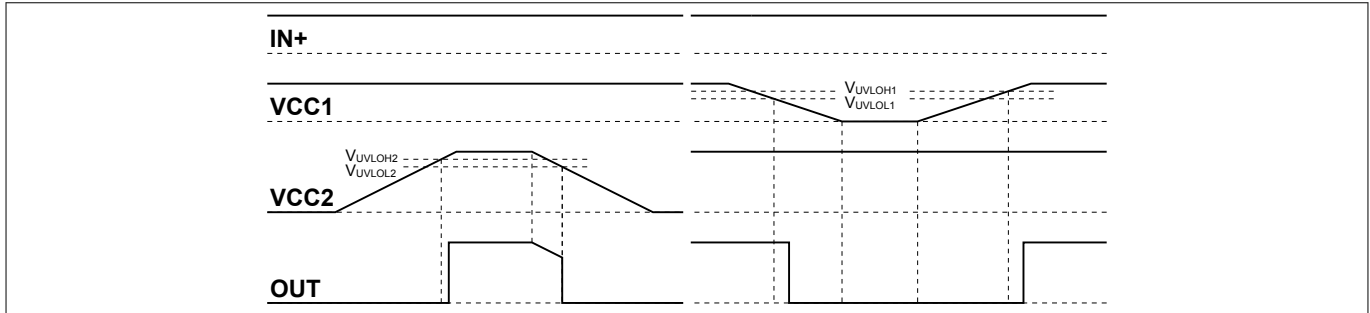


Figure 8 UVLO behavior

To ensure correct switching of IGBTs the device is equipped with an undervoltage lockout for input and output independently. Operation starts only after both VCC levels have increased beyond the respective V_{UVLOH} levels.

If the power supply voltage V_{VCC1} of the input chip drops below V_{UVLOL1} a turn-off signal is sent to the output chip before power-down. The IGBT is switched off and the signals at $IN+$ and $IN-$ are ignored until V_{VCC1} reaches the power-up voltage V_{UVLOH1} again.

If the power supply voltage V_{VCC2} of the output chip goes down below V_{UVLOL2} the IGBT is switched off and signals from the input chip are ignored until V_{VCC2} reaches the power-up voltage V_{UVLOH2} again.

Note: V_{VCC2} is always referred to $VEE2$ and does not differentiate between unipolar or bipolar supply.

4.2.2 Active shut-down

The active shut-down feature ensures a safe IGBT off-state in case the output chip is not connected to the power supply or an undervoltage lockout is in effect. The IGBT gate is clamped at $OUT-$ or $CLAMP$ to $VEE2$.

4.2.3 Short circuit clamping

During short circuit the IGBTs gate voltage tends to rise because of the feedback via the Miller capacitance. An internal protection circuit at $OUT+$ or $CLAMP$ limits this voltage to a value slightly higher than the supply voltage. A maximum current of 500 mA may be fed back to the supply through this path for 10 μ s. If higher currents are expected or tighter clamping is desired external Schottky diodes may be added.

4.2.4 Active Miller clamp

In a half bridge configuration the switched off IGBT tends to dynamically turn on during turn on phase of the opposite IGBT. A Miller clamp allows sinking the Miller current across a low impedance path in this high dV/dt situation. Therefore in many applications, the use of a negative supply voltage can be avoided. During turn-off, the gate voltage is monitored and the clamp output is activated when the gate voltage drops below typical 2 V (referred to $VEE2$). The clamp is designed for a Miller current in the same range as the nominal output current.

4 Functional description

4.3 Non-inverting and inverting inputs

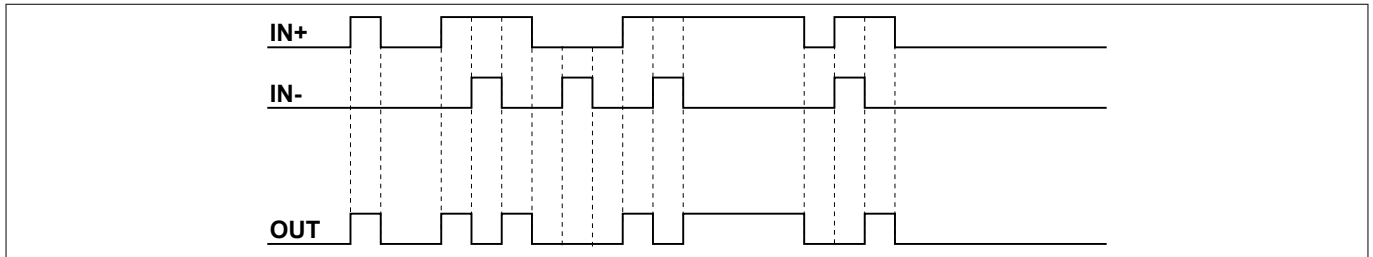


Figure 9 Logic input to output switching behavior

There are two possible input modes to control the IGBT. At non-inverting mode *IN+* controls the driver output while *IN-* is set to low. At inverting mode *IN-* controls the driver output while *IN+* is set to high. A minimum input pulse width is defined to filter occasional glitches.

4.4 Driver outputs

The output driver section uses MOSFETs to provide a rail-to-rail output. This feature permits that tight control of gate voltage during on-state and short circuit can be maintained as long as the driver's supply is stable. Due to the low internal voltage drop, switching behavior of the IGBT is predominantly governed by the gate resistor. Furthermore, it reduces the power to be dissipated by the driver.

5 Electrical characteristics and parameters

5 Electrical characteristics and parameters

5.1 Absolute maximum ratings

Absolute maximum ratings are defined as ratings, which when being exceeded may lead to destruction of the integrated circuit. Unless otherwise noted all parameters refer to *GND1*.

Table 4 Absolute maximum ratings

| Parameter | Symbol | Values | | Unit | Note or test condition |
|--|-----------------------|---------------------|---------------------|------|---|
| | | Min. | Max. | | |
| Input to output offset voltage | V_{OFFSET} | - | 2300 | V | $V_{\text{VEE2,max}} - V_{\text{VEE2,min}}$ with $V_{\text{VEE2,max}} \geq V_{\text{GND1}} \geq V_{\text{VEE2,min}}$ ^{1) 2)} |
| Power supply output side | V_{VCC2} | -0.3 | 40 | V | ³⁾ |
| Gate driver output (<i>OUT+</i> , <i>OUT-</i> , <i>OUT</i> , <i>CLAMP</i>) | V_{OUT} | $\text{VEE2} - 0.3$ | $\text{VCC2} + 0.3$ | V | ³⁾ |
| Power supply input side | V_{VCC1} | -0.3 | 17 | V | $\text{VCC1} - \text{GND1}$ |
| Logic input voltages (<i>IN+</i> , <i>IN-</i>) | V_{IN} | -0.3 | 6.5 | V | $\text{IN} - \text{GND1}$ |
| Junction temperature | T_{J} | -40 | 150 | °C | - |
| Storage temperature | T_{Stg} | -55 | 150 | °C | - |
| Power dissipation (input side) | $P_{\text{D,IN}}$ | - | 100 | mW | $T_{\text{A}} = 65^{\circ}\text{C}$ ⁴⁾ |
| Power dissipation (output side) | $P_{\text{D,OUT}}$ | - | 700 | mW | $T_{\text{A}} = 65^{\circ}\text{C}$ ⁵⁾ |
| Thermal resistance junction to ambient | $R_{\text{thJA,OUT}}$ | - | 88 | K/W | $T_{\text{A}} = 85^{\circ}\text{C}$ 300 mil, 1s0p, $P_{\text{J}} = 266$ mW |
| Characterization parameter junction to package top input side | ψ_{Jtop} | - | 6 | K/W | |
| ESD robustness | $V_{\text{ESD,HBM}}$ | - | 4 | kV | Human body model ⁶⁾ |
| | ESD,CDM | - | TC 1000 | - | Charged device model ⁷⁾ |

- 1) for functional operation only
- 2) See also [Chapter 6](#) on page 17
- 3) With respect to *VEE2*
- 4) IC input-side power dissipation is derated linearly with 11.4 mW/°C above 141 °C
- 5) IC output-side power dissipation is derated linearly with 11.4 mW/°C above 88 °C
- 6) According to ANSI/ESDA/JEDEC-JS-001-2017 (discharging a 100 pF capacitor through a 1.5 kΩ series resistor).
- 7) According to ANSI/ESDA/JEDEC-JS-002-2014 (TC = test condition in volt)

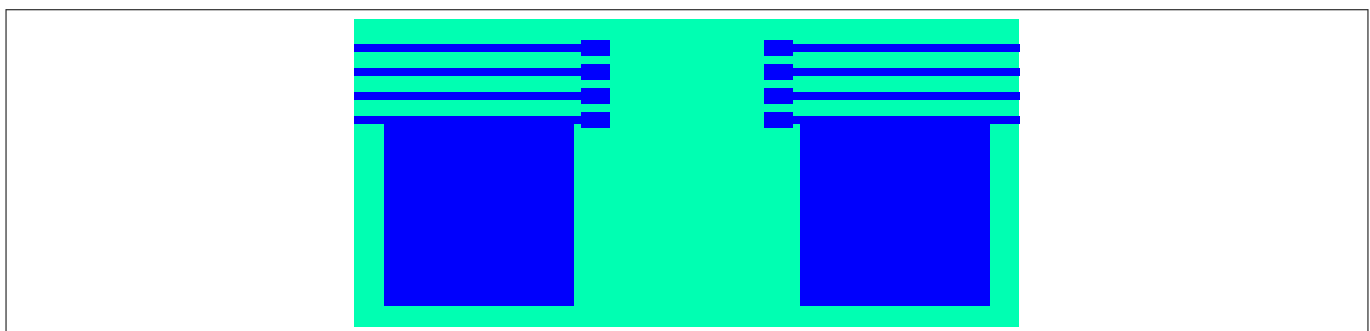


Figure 10 Reference layout for thermal data (Copper thickness 35 μm)

This PCB layout represents the reference layout used for the thermal characterization of the 300 mil package.

5 Electrical characteristics and parameters

5.2 Operating parameters

Within the operating range the IC operates as described in the functional description. Unless otherwise noted all parameters refer to *GND1*.

Table 5 Electrical characteristics

| Parameter | Symbol | Values | | Unit | Note or test condition |
|--|------------|--------|------|-------------|-----------------------------|
| | | Min. | Max. | | |
| Power supply output side | V_{VCC2} | 10 | 35 | V | 1) |
| Power supply input side | V_{VCC1} | 3.1 | 15 | V | – |
| Logic input voltages ($IN+$, $IN-$) | V_{IN} | -0.3 | 5.5 | V | – |
| Switching frequency | f_{SW} | – | 1 | MHz | max P_D applies |
| Ambient temperature | T_A | -40 | 125 | °C | – |
| Common mode transient immunity (CMTI) | CMTI | -200 | 200 | kV/ μ s | $V_{OFFSET, test} = 1500$ V |

1) With respect to *VEE2*

5 Electrical characteristics and parameters

5.3 Electrical characteristics

Note: The electrical characteristics include the spread of values in supply voltages, load and junction temperatures given below. Typical values represent the median values at $T_A = 25^\circ\text{C}$. Unless otherwise noted all voltages are given with respect to their respective GND (GND1 for pins 1 to 3 and VEE2 for pins 6 to 8).

5.3.1 Power supply

Table 6 Power supply

| Parameter | Symbol | Values | | | Unit | Note or test condition |
|----------------------------------|----------------|--------|------|------|---------------|--|
| | | Min. | Typ. | Max. | | |
| UVLO threshold input side (on) | V_{UVLOH1} | – | – | 3.1 | V | – |
| UVLO threshold input side (off) | V_{UVLOL1} | 2.5 | – | – | V | – |
| UVLO hysteresis input side | V_{HYS1} | 0.1 | 0.2 | – | V | – |
| UVLO threshold output side (on) | $V_{UVLOH2,1}$ | – | – | 10.0 | V | 1ED3120MU12H, 1ED3122MU12H, 1ED3123MU12H |
| UVLO threshold output side (off) | $V_{UVLOL2,1}$ | 8.0 | – | – | V | |
| UVLO threshold output side (on) | $V_{UVLOH2,2}$ | – | – | 12.5 | V | 1ED3121MU12H, 1ED3124MU12H, 1ED3131MU12H |
| UVLO threshold output side (off) | $V_{UVLOL2,2}$ | 10.5 | – | – | V | |
| UVLO hysteresis output side | V_{HYS2} | 0.8 | – | – | V | – |
| Quiescent current input side | I_{Q1} | – | – | 1.1 | mA | static, output low |
| Quiescent current output side | I_{Q2} | – | – | 2 | mA | |
| Start up time | t_{START} | – | 2.5 | 20 | μs | 1) |
| UVLO detection filter time | t_{UVLOft} | 50 | – | – | ns | 1) |

1) Parameter is not subject to production test - verified by design/characterization

5.3.2 Logic input

Table 7 Logic input

| Parameter | Symbol | Values | | | Unit | Note or test condition |
|--|--------------|--------|------|------|---------------|--|
| | | Min. | Typ. | Max. | | |
| $IN+$, $IN-$ low input threshold voltage | $V_{IN,L}$ | – | – | 1.1 | V | – |
| $IN+$, $IN-$ high input threshold voltage | $V_{IN,H}$ | 2.5 | – | – | V | – |
| $IN+$, $IN-$ low/high hysteresis | $V_{IN,HYS}$ | 0.5 | 0.8 | – | V | – |
| $IN+$, $IN-$ input current | I_{IN} | – | – | 100 | μA | $V_{VCC1} = 5\text{V}; V_{IN} \leq V_{VCC1}$ |
| $IN+$ pull down resistor | $R_{IN,PD}$ | – | 75 | – | k Ω | – |
| $IN-$ pull up resistor | $R_{IN,PU}$ | – | 75 | – | k Ω | – |

5 Electrical characteristics and parameters

5.3.3 Gate driver

All gate driver output parameters valid for $V_{CC2} = 15\text{ V}$ supply voltage unless specified otherwise.

Table 8 Gate driver

| Parameter | Symbol | Values | | | Unit | Note or test condition |
|--|--------------------|--------|------|------|----------|--|
| | | Min. | Typ. | Max. | | |
| 1ED3120MU12H, 1ED3121MU12H, 1ED3131MU12H | | | | | | |
| High level output peak current | $I_{OUT,H}$ | 2.0 | 5.5 | – | A | 1) $V_{CC2-OUT+} = 15\text{ V}$, Output on |
| High level output on resistance | $R_{DSON,H}$ | 0.60 | 0.95 | 1.45 | Ω | $I_{OUT,H} = 0.1\text{ A}$ |
| Low level output peak current | $I_{OUT,L}$ | 2.0 | 5.5 | – | A | 1) $OUT-VEE2 = 15\text{ V}$, Output off |
| Low level output on resistance | $R_{DSON,L}$ | 0.50 | 0.75 | 1.05 | Ω | $I_{OUT,L} = 0.1\text{ A}$ |
| 1ED3122MU12H | | | | | | |
| High level output peak current | $I_{OUT,H}$ | 4.0 | 10.0 | – | A | 1) $V_{CC2-OUT} = 15\text{ V}$, Output on |
| High level output on resistance | $R_{DSON,H}$ | 0.30 | 0.55 | 0.85 | Ω | $I_{OUT,H} = 0.1\text{ A}$ |
| Low level output peak current | $I_{OUT,L}$ | 4.0 | 9.0 | – | A | 1) $OUT-VEE2 = 15\text{ V}$, Output off |
| Low level output on resistance | $R_{DSON,L}$ | 0.30 | 0.45 | 0.65 | Ω | $I_{OUT,L} = 0.1\text{ A}$ |
| Low level clamp peak current | $I_{CLAMP,L}$ | 2.0 | 3.0 | – | A | 1) $V_{CLAMP} = 2.0\text{ V}$ |
| Low level clamp on resistance | $R_{DSON,CLP}$ | 0.33 | 0.55 | 0.76 | Ω | $I_{CLAMP,L} = 0.1\text{ A}$ |
| CLAMP threshold voltage | V_{CLAMP} | 1.6 | 2.0 | 2.4 | V | CLAMP-VEE2 |
| CLAMP comparator to CLAMP activation delay time | t_{CLPDLY} | – | – | 80 | ns | 1) $V_{CLAMP} \leq 2.0\text{ V}$ |
| 1ED3123MU12H, 1ED3124MU12H | | | | | | |
| High level output peak current | $I_{OUT,H}$ | 6.0 | 13.5 | – | A | 1) $V_{CC2-OUT+} = 15\text{ V}$, Output on |
| High level output on resistance | $R_{DSON,H}$ | 0.27 | 0.45 | 0.65 | Ω | $I_{OUT,H} = 0.1\text{ A}$ |
| Low level output peak current | $I_{OUT,L}$ | 6.0 | 14.0 | – | A | 1) $OUT-VEE2 = 15\text{ V}$, Output off |
| Low level output on resistance | $R_{DSON,L}$ | 0.21 | 0.35 | 0.60 | Ω | $I_{OUT,L} = 0.1\text{ A}$ |
| all variants | | | | | | |
| High level output voltage | $\Delta V_{OUT,H}$ | – | – | 0.3 | V | $V_{CC2}-V_{OUT,H}$; $I_{OUT} = 20\text{ mA}$ |
| Low level output voltage | $\Delta V_{OUT,L}$ | – | – | 0.1 | V | $V_{CC2}-V_{OUT,H}$; $I_{OUT} = 20\text{ mA}$ |
| Short circuit clamp voltage between $OUT+/CLAMP$ and V_{CC2} | V_{CLP} | – | – | 2.0 | V | Output on, $I_{OUT} = 500\text{ mA}$, $t < 10\text{ }\mu\text{s}$ |

1) Parameter is not subject to production test - verified by design/characterization

5 Electrical characteristics and parameters

5.3.4 Dynamic characteristics

Dynamic characteristics are measured with $V_{VCC1} = 5\text{ V}$ and $V_{VCC2} = 15\text{ V}$.

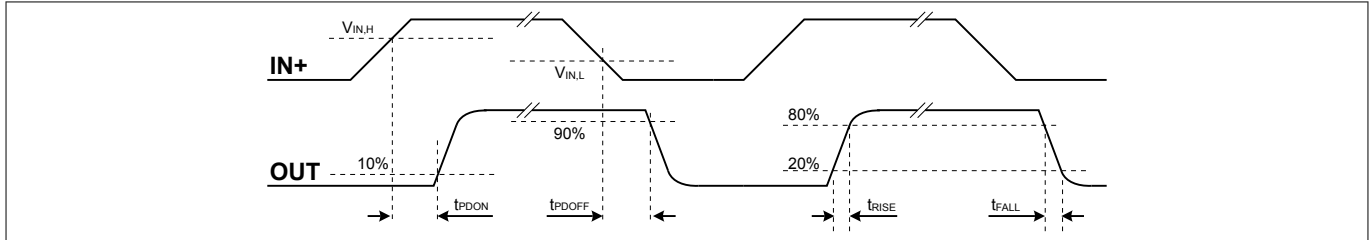


Figure 11 Propagation delay, rise and fall time

Table 9 Filter and propagation delay characteristics (1ED3131MU12H only)

| Parameter | Symbol | Values | | | Unit | Note or test condition |
|---|------------------|--------|------|------|------|--|
| | | Min. | Typ. | Max. | | |
| Input to output propagation delay ON | t_{PDON} | – | 270 | 280 | ns | $C_{LOAD} = 100\text{ pF}$, IN turn-on threshold to 10% output on |
| Input to output propagation delay OFF | t_{PDOFF} | – | 270 | 280 | ns | $C_{LOAD} = 100\text{ pF}$, IN turn-off threshold to 90% output off |
| Input to output propagation delay distortion | t_{PDISTO} | -15 | 0 | 15 | ns | $t_{PDOFF} - t_{PDON}$ |
| Input pulse suppression time (filter time) | t_{INFLT} | 180 | – | – | ns | shorter pulses will not propagate to the output |
| Minimum input pulse length | t_{MININ} | – | – | 220 | ns | – |
| Input to output propagation delay variation due to temperature | $t_{PD,T}$ | – | – | 14 | ns | 1) |
| Input to output propagation delay distortion variation due to temperature | $t_{PDISTO,T}$ | – | – | 5 | ns | 1) |
| Input to output, part to part propagation delay ON variation | $ t_{PDOn,P2P} $ | – | – | 15 | ns | 1) 2) $C_{LOAD} = 100\text{ pF}$ |

1) Parameter is not subject to production test - verified by design/characterization

Table 10 Filter and propagation delay characteristics (all other variants)

| Parameter | Symbol | Values | | | Unit | Note or test condition |
|---------------------------------------|-------------|--------|------|------|------|--|
| | | Min. | Typ. | Max. | | |
| Input to output propagation delay ON | t_{PDON} | 80 | 90 | 100 | ns | $C_{LOAD} = 100\text{ pF}$, IN turn-on threshold to 10% output on |
| Input to output propagation delay OFF | t_{PDOFF} | 80 | 90 | 100 | ns | $C_{LOAD} = 100\text{ pF}$, IN turn-off threshold to 90% output off |

5 Electrical characteristics and parameters

Table 10 Filter and propagation delay characteristics (all other variants) (continued)

| Parameter | Symbol | Values | | | Unit | Note or test condition |
|---|-------------------|--------|------|------|------|---|
| | | Min. | Typ. | Max. | | |
| Input to output propagation delay distortion | t_{PDISTO} | -5 | 0 | 5 | ns | $t_{PD OFF} - t_{PD ON}$ |
| Input pulse suppression time (filter time) | t_{INFLT} | 30 | - | - | ns | shorter pulses will not propagate to the output |
| Minimum input pulse length | t_{MININ} | - | - | 40 | ns | - |
| Input to output propagation delay variation due to temperature | $t_{PD,T}$ | - | - | 14 | ns | 1) |
| Input to output propagation delay distortion variation due to temperature | $t_{PDISTO,T}$ | - | - | 3 | ns | 1) |
| Input to output, part to part propagation delay ON variation | $ t_{PD on,P2P} $ | - | - | 7 | ns | 1) 2) $C_{LOAD} = 100 \text{ pF}$ |

1) Parameter is not subject to production test - verified by design/characterization

2) Absolute value at same ambient and operating conditions.

Table 11 Dynamic output characteristics

| Parameter | Symbol | Values | | | Unit | Note or test condition |
|-----------|------------|--------|------|------|------|-----------------------------|
| | | Min. | Typ. | Max. | | |
| Rise time | t_{RISE} | - | - | 15 | ns | $C_{LOAD} = 100 \text{ pF}$ |
| Fall time | t_{FALL} | - | - | 15 | ns | $C_{LOAD} = 100 \text{ pF}$ |
| Rise time | t_{RISE} | - | - | 30 | ns | $C_{LOAD} = 1 \text{ nF}$ |
| Fall time | t_{FALL} | - | - | 30 | ns | $C_{LOAD} = 1 \text{ nF}$ |

5.3.5 Active shut down

Table 12 Active shut down

| Parameter | Symbol | Values | | | Unit | Note or test condition |
|--------------------------------|---------------|--------|------|------|------|---|
| | | Min. | Typ. | Max. | | |
| Active shut down voltage, cold | $V_{ACTSD,C}$ | - | - | 1.9 | V | $I_{OUT} = 10 \text{ mA}$; V_{CC2} un-supplied; $T_A < 20^\circ\text{C}$ |
| Active shut down voltage, hot | $V_{ACTSD,H}$ | - | - | 1.7 | V | 1) $I_{OUT} = 10 \text{ mA}$; V_{CC2} un-supplied; $T_A \geq 20^\circ\text{C}$ |

1) Parameter is not subject to production test - verified by design/characterization

6 Insulation characteristics

6 Insulation characteristics

Table 13 Safety limiting values

This coupler is suitable for rated insulation only within the given safety limiting values. Compliance with the safety limiting values shall be ensured by means of suitable protective circuits.

| Description | Symbol | Characteristic | Unit |
|--|----------|----------------|------|
| Maximum ambient safety temperature | T_S | 150 | °C |
| Maximum input-side power dissipation at $T_A = 25^\circ\text{C}^{1)}$ | P_{SI} | 100 | mW |
| Maximum output-side power dissipation at $T_A = 25^\circ\text{C}^{2)}$ | P_{SO} | 1314 | mW |

1) IC input-side power dissipation is derated linearly with 11.4 mW/°C above 141 °C

2) IC output-side power dissipation is derated linearly with 8.8 mW/°C above 25°C

Table 14 Package specific insulation characteristics

| Description | Symbol | Characteristic | Unit |
|------------------------------------|----------|----------------|------|
| Minimum external clearance | CLR | >8 | mm |
| Minimum external creepage | CPG | >8 | mm |
| Minimum comparative tracking index | CTI | 400 | – |
| Insulation capacitance | C_{I0} | 0.9 | pF |

6.1 Recognized under UL 1577 (File E311313)

Table 15 Recognized under UL 1577

| Description | Symbol | Characteristic | Unit |
|------------------------------------|-----------------|----------------|---------|
| Insulation withstand voltage/1 min | V_{ISO} | 5700 | V (rms) |
| Insulation test voltage/1 s | $V_{ISO, TEST}$ | 6840 | V (rms) |

7 Package dimensions

7 Package dimensions

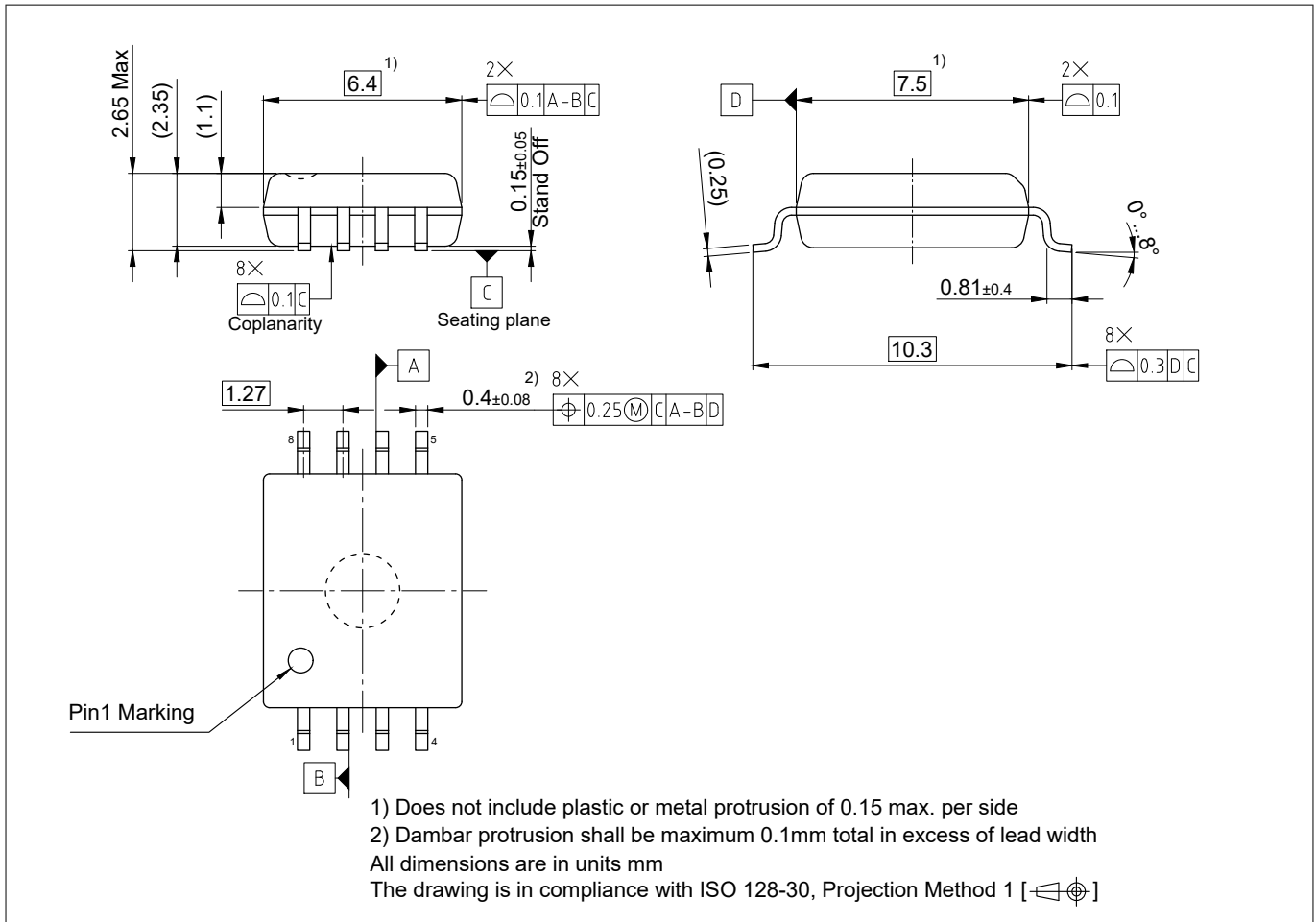


Figure 12 PG-DSO-8 (Plastic (green) dual small outline package, 300 mil)

Revision history

Revision history

Revision history

| Reference | Description |
|------------------|--|
| v2.1 | <ul style="list-style-type: none">• $R_{\text{DS(on)}}$ parameter values update• Safety limiting values derived from 1ED31xxMC12H datasheet• Update to ESD,CDM footnote and package outline drawing |
| v2.0 | Final datasheet with parameter updates |
| v1.0 | Preliminary datasheet with parameter updates |

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